DMA2610M

Silicon PNP epitaxial planar type

For digital circuits

Features

- \bullet Low collector-emitter saturation voltage $V_{\mbox{CE(sat)}}$
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

Marking Symbol: S1

Basic Part Number

Dual DRA2123J (Common emitter)

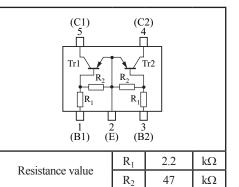
Packaging

DMA2610M0R Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

Absolute Maximum Ratings $T_a = 25^{\circ}C$

| | Parameter | Symbol Rating | | Unit |
|------------|---------------------------------------|----------------------|-------------|------|
| Tr1 Tr2 | Collector-base voltage (Emitter open) | V _{CBO} | -50 | V |
| | Collector-emitter voltage (Base open) | V _{CEO} -50 | | V |
| | Collector current | I _C | -100 | mA |
| Overall | Total power dissipation | P _T | 300 | mW |
| | Junction temperature | Tj | 150 | °С |
| | Operating ambient temperature | T _{opr} | -40 to +85 | °C |
| | Storage temperature | T _{stg} | -55 to +150 | °C |

Unit: mm 2.9 0.3 0.13 Ħ 4 ω 2 2 2 3 1 (0.95) (0.95) 1.9 1: Base (Tr1) 4: Collector (Tr2) 5: Collector (Tr1) 2: Emitter (Common) 3: Base (Tr2) Mini5-G3-B Panasonic JEITA SC-74A Code MO-178



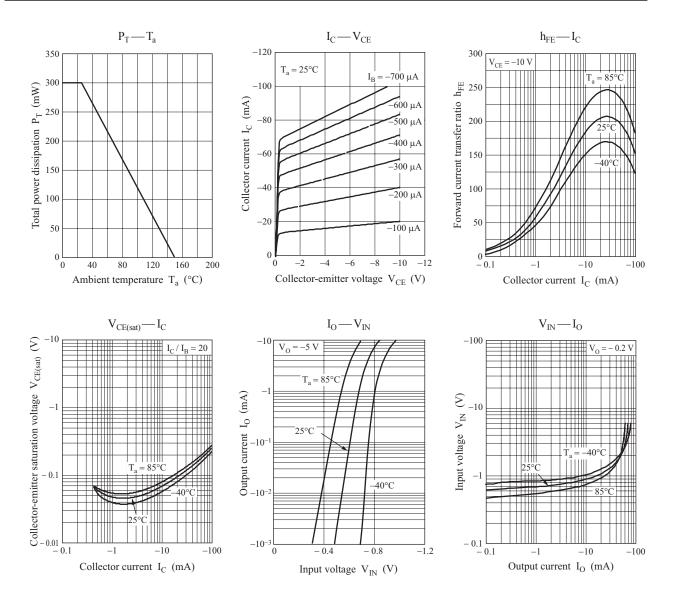
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------------------------------|---|-------|-------|-------|------|
| Collector-base voltage (Emitter open) | V _{CBO} | $I_{\rm C} = -10 \ \mu {\rm A}, I_{\rm E} = 0$ | -50 | | | V |
| Collector-emitter voltage (Base open) | V _{CEO} | $I_{\rm C} = -2 {\rm mA}, I_{\rm B} = 0$ | -50 | | | V |
| Collector-base cutoff current (Emitter open) | I _{CBO} | $V_{CB} = -50 \text{ V}, I_E = 0$ | | | -0.1 | μΑ |
| Collector-emitter cutoff current (Base open) | I _{CEO} | $V_{\rm CE} = -50 \text{ V}, I_{\rm B} = 0$ | | | -0.5 | μΑ |
| Emitter-base cutoff current (Collector open) | I _{EBO} | $V_{\rm EB} = -6$ V, $I_{\rm C} = 0$ | | | - 0.2 | mA |
| Forward current transfer ratio | h _{FE} | $V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$ | 80 | | | |
| h _{FE} ratio *1 | h _{FE} (Small/Large) | $V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$ | 0.50 | 0.99 | | |
| Collector-emitter saturation voltage | V _{CE(sat)} | $I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -0.5 \text{ mA}$ | | | -0.25 | V |
| Input voltage (ON) | V _{I(on)} | $V_{CE} = -0.2 \text{ V}, I_C = -5 \text{ mA}$ | -1.2 | | | V |
| Input voltage (OFF) | V _{I(off)} | $V_{CE} = -5 \text{ V}, I_C = -100 \mu\text{A}$ | | | -0.4 | V |
| Input resistance | R ₁ | | -30% | 2.2 | +30% | kΩ |
| Resistance ratio | R ₁ / R ₂ | | 0.037 | 0.047 | 0.057 | |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

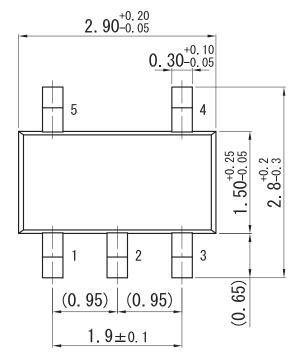
2. *1: Ratio between 2 elements

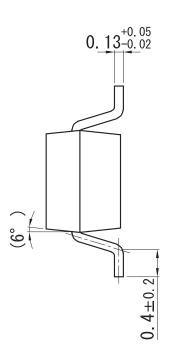
Panasonic

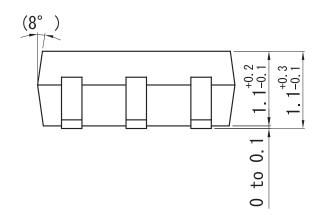


Unit: mm

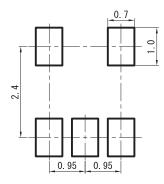
Mini5-G3-B







Land Pattern (Reference) (Unit: mm)



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